

Kingtronics®**MB1F THRU
MB10F**

SURFACE MOUNT FAST SWITCHING RECTIFIER
REVERSE VOLTAGE 50 to 1000 Volts FORWARD CURRENT 1.0 Ampere

FEATURES

Glass passivated chip junction
 Ideal for surface mounted applications
 Low leakage
 High forward surge current capability
 High temperature soldering guaranteed:
 260°C/10 seconds at terminals

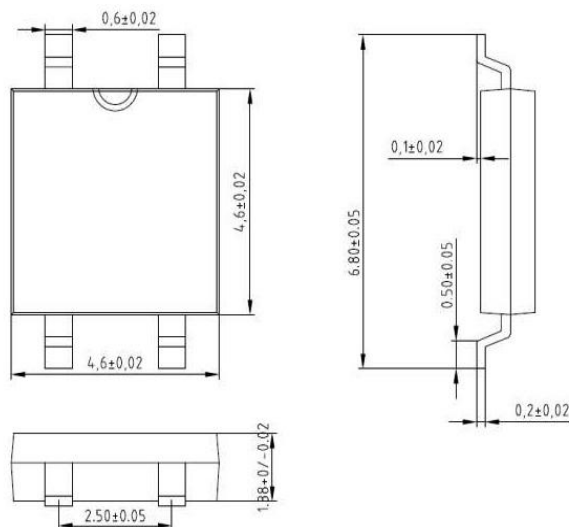
MECHANICAL DATA

Case: Molded plastic body
 Epoxy: UL94V-0 rate flame retardant
 Polarity: Molded on body
 Lead: Plated terminals solderable per MIL-STD-202E
 method 208C
 Weight: 0.003 ounce, 0.1 gram

**MAXIMUM RATINGS AND ELECTRICAL
CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified ,
 Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load derate current by 20%

Dimensions in inches and (millimeters)



PARAMETER	SYMBOL	MB1F	MB2F	MB3F	MB4F	MB6F	MB8F	MB10F	UNIT
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Output Current, 0.06"(1.5mm) lead length at $T_A=40^\circ\text{C}$ (Note 2)	I_{AV}	1.0							A
Peak Forward Surge Current, 8.3ms single half-sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	30							A
Rating for Fusing ($t < 8.3\text{ms}$)	I^2t	10							A ² s
Maximum Instantaneous Forward Voltage drop Per Bridge element 1.0A	V_F	1.1							V
Maximum DC Reverse Current at $T_A=25^\circ\text{C}$ at Rated DC Blocking voltage $T_A=125^\circ\text{C}$	I_R	5.0							uA
		0.5							mA
Typical Junction Capacitance (Note 1)	C_J	25							pF
Typical Thermal Resistance (Note 2)	$R_{\theta JC}$	40							°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150							°C

1- Measured at 1.0MHz and applied reverse voltage of 4.0 Volts.

2- Unit mounted on P.C.B. with 0.95"×1.15" copper pads.

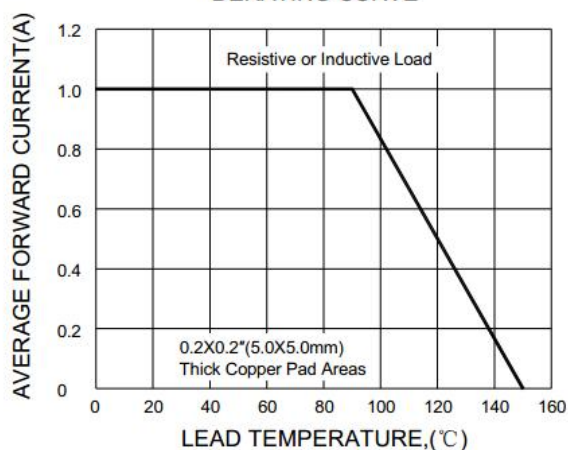
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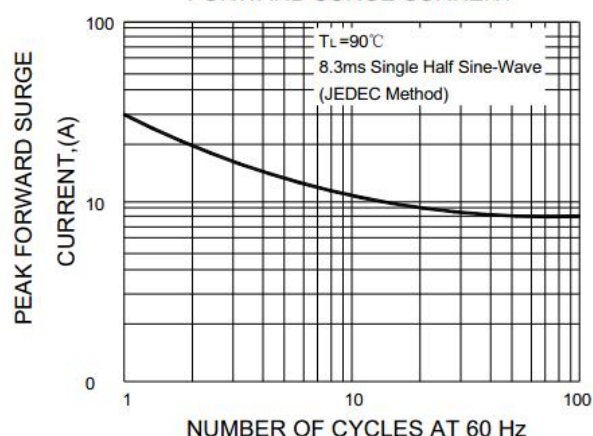
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RATINGS AND CHARACTERISTIC CURVES

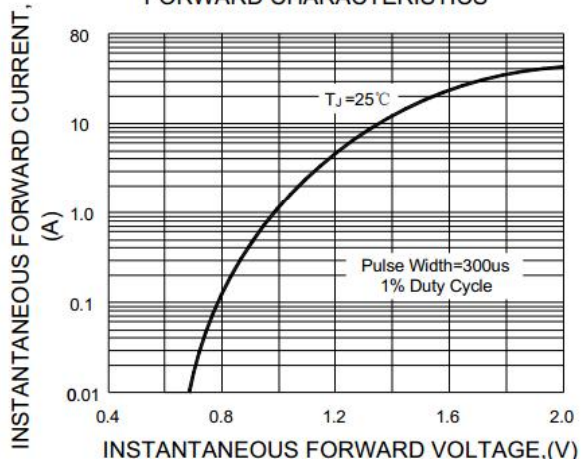
F1G.1-FORWARD CURRENT
DERATING CURVE



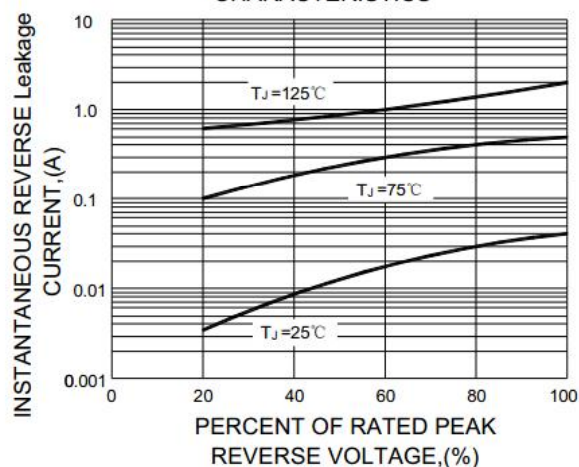
F1G.2-MAXIMUM NON-REPETITIVE PEAK
FORWARD SURGE CURRENT



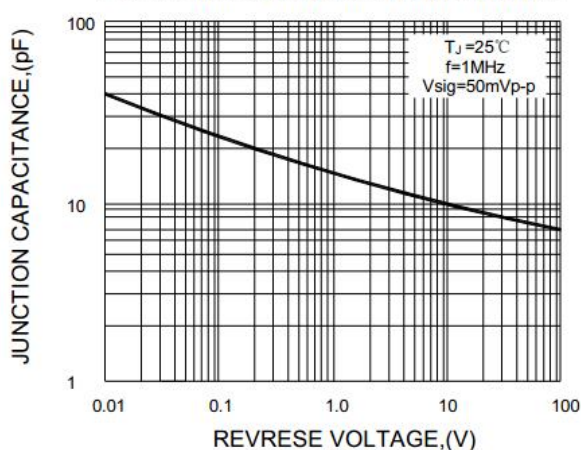
F1G.3-TYPICAL INSTANTANEOUS
FORWARD CHARACTERISTICS



F1G.4-TYPICAL REVERSE
CHARACTERISTICS



F1G.5-TYPICAL JUNCTION CAPACITANCE



Note: Specifications are subject to change without notice.

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